

Sub-5 nm bilayer GaSe MOSFETs towards ultrahigh on-state current

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Supplementary Information

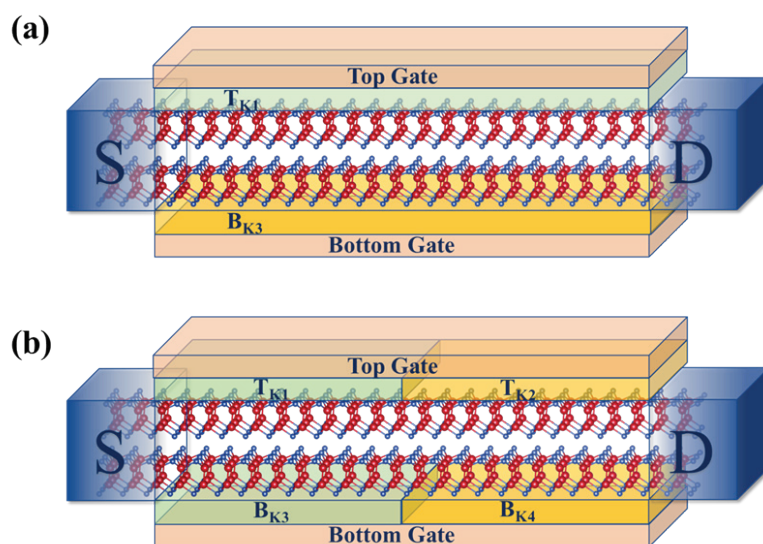


Fig. S1 The designed device of (a) type-A and (b) type-B.

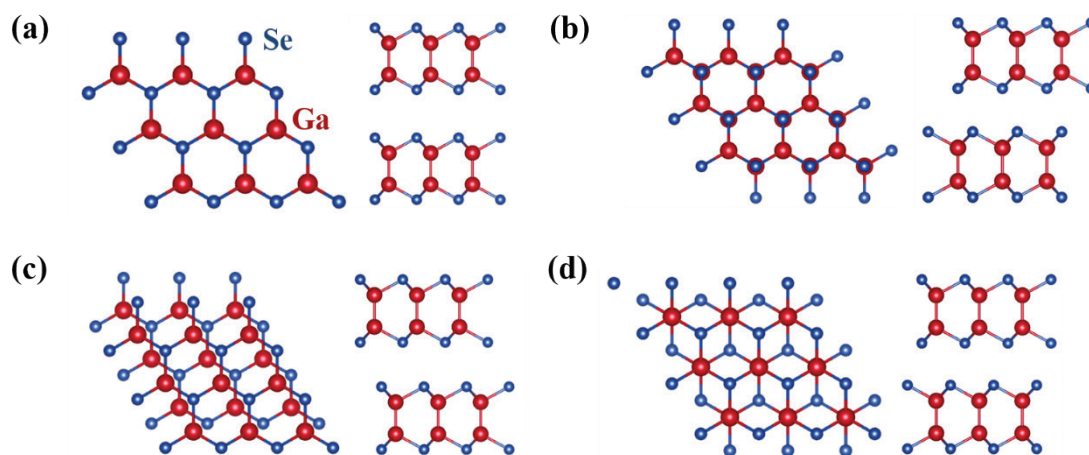


Fig. S2 The top and side views of bilayer GaSe (a-d) AA, AB, AC, and AD stackings. Red spheres represent Ga atoms, and blue spheres represent Se atoms.

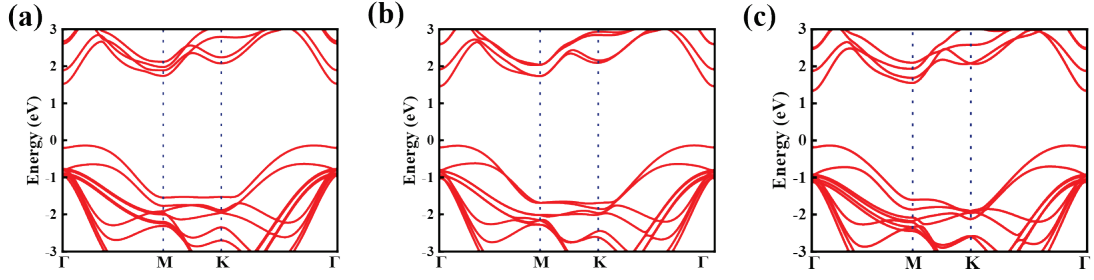


Fig. S3 The band structures of (a) AA, (b) AC, and (c) AD stacking.

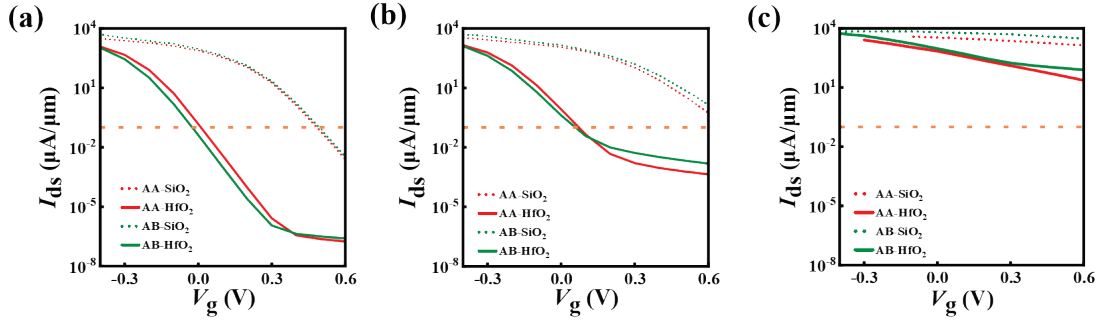


Fig. S4 Transfer characteristic curves of the devices with AA and AB stacking at (b) $L_g = 5$ nm, (c) $L_g = 3$ nm, and (d) $L_g = 1$ nm.

Table S1 The main parameters of four stackings.

	AA	AB	AC	AD
Formation energy (eV)	-1.94255	-2.01778	-1.99866	-2.02071
E_g (eV)	1.66	1.50	1.59	1.48
Distance (Å)	3.7387	3.1806	3.466	3.1775